

# DISCRETE POWER DIODES and THYRISTORS DATA BOOK



## ST280C..C SERIES

#### **PHASE CONTROL THYRISTORS**

#### **Hockey Puk Version**

#### Features

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)

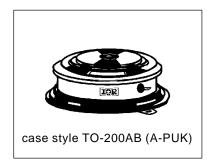
#### **Typical Applications**

- DC motor controls
- Controlled DC power supplies
- AC controllers

#### Major Ratings and Characteristics

Parameters		ST280CC	Units	
I <sub>T(AV)</sub>		500	А	
	@ T <sub>hs</sub>	55	°C	
I <sub>T(RMS)</sub>		960	А	
	@ T <sub>hs</sub>	25	°C	
I <sub>TSM</sub>	@ 50Hz	7850	А	
	@ 60Hz	8220	А	
I <sup>2</sup> t	@ 50Hz	308	KA <sup>2</sup> s	
	@ 60Hz	281	KA <sup>2</sup> s	
V <sub>DRM</sub> /V <sub>RRM</sub>		400 to 600	٧	
t <sub>q</sub>	typical	100	μs	
T <sub>J</sub>		- 40 to 125	°C	

500A



# ELECTRICAL SPECIFICATIONS Voltage Ratings

	,-				
Type number	Voltage Code	$V_{\mathrm{DRM}}/V_{\mathrm{RRM}},$ max. repetitive peak and off-state voltage	V <sub>RSM</sub> , maximum non- repetitive peak voltage	$I_{DRM}/I_{RRM}$ max. @ $T_J = T_J$ max	
		V	V	mA	
ST280CC	04	400	500	30	
3120000	06	600	700	30	

#### On-state Conduction

	Parameter	ST280CC	Units	Conditions	Conditions		
I <sub>T(AV)</sub>	Max. average on-state current	500 (185)	Α	180° conduction, half sine wave		wave	
` ′	@ Heatsink temperature	55 (85)	°C	double side	e (single side) o	cooled	
I <sub>T(RMS)</sub>	Max. RMS on-state current	960		DC @ 25°C	heatsink temp	perature double side cooled	
I <sub>TSM</sub>	Max. peak, one-cycle	7850		t = 10ms	No voltage		
	non-repetitive surge current	8220	Α	t = 8.3ms	reapplied		
		6600		t = 10ms	100% V <sub>RRM</sub>		
		6900		t = 8.3ms	reapplied	Sinusoidal half wave,	
I <sup>2</sup> t	Maximum I <sup>2</sup> t for fusing	308		t = 10ms	No voltage	Initial $T_J = T_J$ max.	
		281	KA <sup>2</sup> s	t = 8.3ms	reapplied		
		218	KA S	t = 10ms	100% V <sub>RRM</sub>		
		200		t = 8.3ms	reapplied		
I <sup>2</sup> √t	Maximum I <sup>2</sup> √t for fusing	3080	KA <sup>2</sup> √s	t = 0.1 to 1	t = 0.1 to 10ms, no voltage reapplied		
V <sub>T(TO)1</sub>	Low level value of threshold voltage	0.84	.,	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J$		$x I_{T(AV)}$ ), $T_J = T_J max$ .	
V <sub>T(TO)2</sub>	High level value of threshold voltage	0.88	V	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$			
r <sub>t1</sub>	Low level value of on-state slope resistance	0.50	mΩ	(16.7% x π	x I <sub>T(AV)</sub> < I < π	$x I_{T(AV)}, T_J = T_J max.$	
r <sub>t2</sub>	High level value of on-state slope resistance	0.47	11152	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$			
V <sub>TM</sub>	Max. on-state voltage	1.36	V	$I_{pk}$ = 1050A, $T_{J}$ = 125°C, $t_{p}$ = 10ms sine		p = 10ms sine pulse	
I <sub>H</sub>	Maximum holding current	600	1	$T_J = 25$ °C, anode supply 12V resis		40\/	
IL	Max. (typical) latching current	1000 (300)	mA			/ 12v resistive load	

#### Switching

	Parameter	ST280CC	Units	Conditions
di/dt	Max. non-repetitive rate of rise of turned-on current	1000	A/µs	Gate drive 20V, $20\Omega$ , $t_r \le 1\mu s$ $T_J = T_J \text{ max}$ , anode voltage $\le 80\% \text{ V}_{DRM}$
t <sub>d</sub>	Typical delay time	1.0	- μs	Gate current 1A, di $_{g}$ /dt = 1A/ $\mu$ s $V_{d}$ = 0.67% $V_{DRM}$ , $T_{J}$ = 25°C
t <sub>q</sub>	Typical turn-off time	100		$I_{TM} = 300A$ , $T_J = T_J$ max, di/dt = 20A/ $\mu$ s, $V_R = 50V$ dv/dt = 20V/ $\mu$ s, Gate 0V 100 $\Omega$ , $t_p = 500\mu$ s

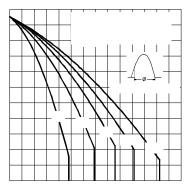


Fig. 3 - Current Ratings Characteristics

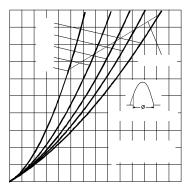


Fig. 5- On-state Power Loss Characteristics

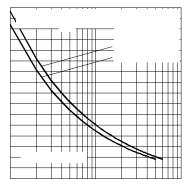


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

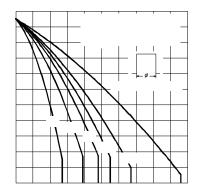


Fig. 4 - Current Ratings Characteristics

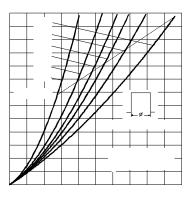


Fig. 6- On-state Power Loss Characteristics

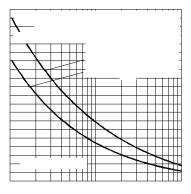


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

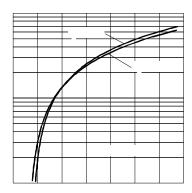


Fig. 9 - On-state Voltage Drop Characteristics

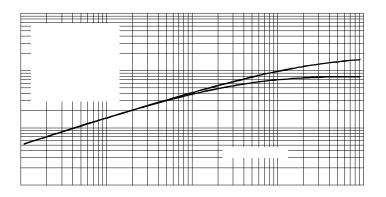


Fig. 10 - Thermal Impedance  $Z_{thJ\text{-}hs}$  Characteristics

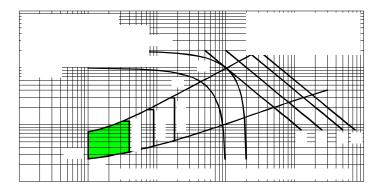


Fig. 11 - Gate Characteristics

#### Blocking

	Parameter	ST280CC	Units	Conditions
dv/dt	Maximum critical rate of rise of off-state voltage	500	V/µs	$T_J = T_J$ max. linear to 80% rated $V_{DRM}$
I <sub>DRM</sub> I <sub>RRM</sub>	Max. peak reverse and off-state leakage current	30	mA	$T_J = T_J \text{ max, rated } V_{DRM} / V_{RRM} \text{ applied}$

#### Triggering

	Parameter	ST280CC		Units	Conditions		
P <sub>GM</sub>	Maximum peak gate power	10.0		10/	$T_J = T_J \text{ max, } t_p \le 5 \text{ms}$		
$P_{G(AV)}$	Maximum average gate power			W	$T_J = T_J \text{ max, } f = 50 \text{Hz, } d\% = 50$		
I <sub>GM</sub>	Max. peak positive gate current	3.	0	Α	$T_J = T_J \text{ max, } t_p \le 5 \text{ms}$		
+V <sub>GM</sub>	Maximum peak positive gate voltage	20		.,	$T_J = T_J \text{ max, } t_p \le 5 \text{ms}$		
-V <sub>GM</sub>	Maximum peak negative gate voltage			V			
	DC gate current required to trigger	TYP.	MAX.	mA			
I <sub>GT</sub>		180 90	- 150		$T_{J} = -40^{\circ}C$		
		40	-	IIIA	$T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$	Max. required gate trigger/ cur- rent/voltage are the lowest value	
		2.9	-		T <sub>J</sub> = - 40°C	which will trigger all units 12V anode-to-cathode applied	
V <sub>GT</sub>	DC gate voltage required to trigger	1.8	3.0	V	$T_J = 25^{\circ}C$	arroad to datridad applied	
	to trigger	1.2	-		T <sub>J</sub> = 125°C		
I <sub>GD</sub>	DC gate current not to trigger	0.30		mA		Max. gate current/voltage not to	
V <sub>GD</sub>	DC gate voltage not to trigger			V	$T_J = T_J \text{ max}$	trigger is the max. value which will not trigger any unit with rated V <sub>DRM</sub> anode-to-cathode applied	

#### Thermal and Mechanical Specification

	Parameter	ST280CC	Units	Conditions
T <sub>J</sub>	Max. operating temperature range	-40 to 125	°C	
T <sub>stg</sub>	Max. storage temperature range	-40 to 150		
R <sub>thJ-hs</sub>	Max. thermal resistance,	0.17	IZ (\A)	DC operation single side cooled
	junction to heatsink	0.08	K/W	DC operation double side cooled
R <sub>thC-h</sub>	Max. thermal resistance,	0.033	K/W	DC operation single side cooled
	case to heatsink	0.017	IX/VV	DC operation double side cooled
F	Mounting force, ± 10%	4900	N	
		(500)	(Kg)	
wt	Approximate weight	50	g	
Case style		TO - 200AB (A-PUK)		See Outline Table

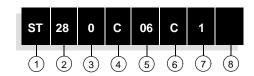
### $\Delta R_{thJ-hs}$ Conduction

(The following table shows the increment of thermal resistence  $R_{thJ+hs}$  when devices operate at different conduction angles than DC)

- 4				110 113			
	Conduction and	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Conduction angle	Single Side	Double Side			Units	Conditions
	180°	0.016	0.016	0.011	0.011		$T_J = T_J \text{ max.}$
	120°	0.019	0.019	0.019	0.019		
	90°	0.024	0.024	0.026	0.026	K/W	
l	60°	0.035	0.035	0.036	0.037		
ı	30°	0.060	0.060	0.060	0.061		,

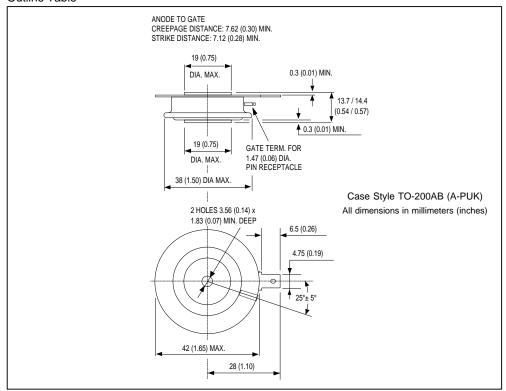
#### Ordering Information Table

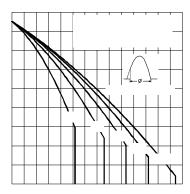
**Device Code** 



- 1 Thyristor
- 2 Essential part number
- **3** 0 = Converter grade
- 4 C = Ceramic Puk
- 5 Voltage code: Code x 100 = V<sub>RRM</sub> (See Voltage Rating Table)
- 6 C = Puk Case TO-200AB (A-PUK)
- 7 0 = Eyelet terminals (Gate and Auxiliary Cathode Unsoldered Leads)
  - 1 = Fast-on terminals (Gate and Auxiliary Cathode Unsoldered Leads)
  - 2 = Eyelet terminals (Gate and Auxiliary Cathode Soldered Leads)
  - 3 = Fast-on terminals (Gate and Auxiliary Cathode Soldered Leads)
- 8 Critical dv/dt: None = 500V/µsec (Standard selection)
  - L = 1000V/µsec (Special selection)

#### Outline Table







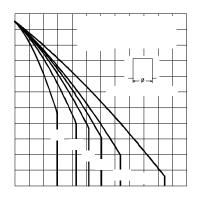


Fig. 2 - Current Ratings Characteristics